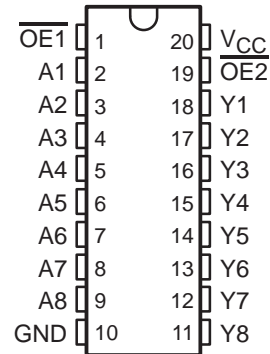


SN74LVC541 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCAS298B – JANUARY 1993 – REVISED JULY 1995

- **EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process**
- **Typical V_{OLP} (Output Ground Bounce) $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{OH} Undershoot) $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$**
- **Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages**

DB, DW, OR PW PACKAGE
(TOP VIEW)



description

This octal buffer/driver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVC541 is ideal for driving bus lines or buffering memory address registers. The device features inputs and outputs on opposite sides of the package to facilitate printed-circuit-board layout.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all eight outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC541 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE

| INPUTS | | | OUTPUT |
|------------------|------------------|---|--------|
| $\overline{OE1}$ | $\overline{OE2}$ | A | Y |
| L | L | L | L |
| L | L | H | H |
| H | X | X | Z |
| X | H | X | Z |



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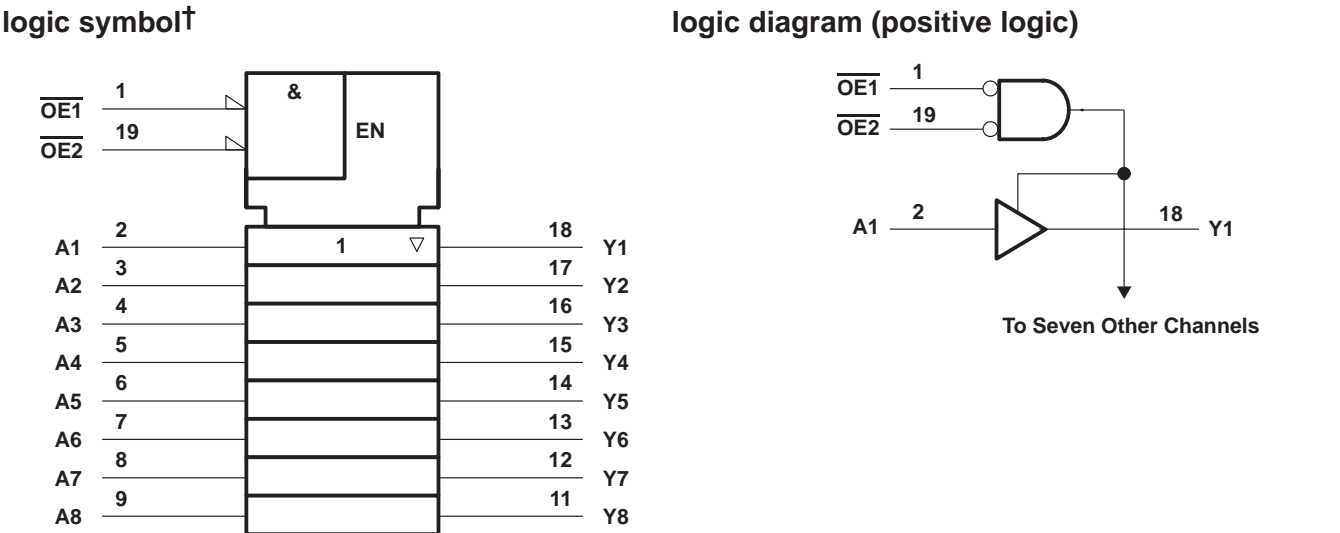
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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|--|----------------------------|
| Supply voltage range, V_{CC} | −0.5 V to 4.6 V |
| Input voltage range, V_I (see Note 1) | −0.5 V to 6.5 V |
| Output voltage range, V_O (see Notes 1 and 2) | −0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | −50 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±50 mA |
| Continuous current through V_{CC} or GND | ±100 mA |
| Maximum power dissipation at $T_A = 55^{\circ}\text{C}$ (in still air) (see Note 3): | |
| DB package | 0.6 W |
| DW package | 1.6 W |
| PW package | 0.7 W |

| | |
|--------------------------------------|----------------|
| Storage temperature range, T_{stg} | −65°C to 150°C |
|--------------------------------------|----------------|

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
- The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - This value is limited to 4.6 V maximum.
 - The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

SN74LVC541
OCTAL BUFFER/DRIVER
WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 4)

| | | | MIN | MAX | UNIT |
|---------------------|------------------------------------|--|-----|----------|------|
| V_{CC} | Supply voltage | | 2.7 | 3.6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2 | | V |
| V_{IL} | Low-level input voltage | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | | 0.8 | V |
| V_I | Input voltage | | 0 | 5.5 | V |
| V_O | Output voltage | | 0 | V_{CC} | V |
| I_{OH} | High-level output current | $V_{CC} = 2.7 \text{ V}$ | | –12 | mA |
| | | $V_{CC} = 3 \text{ V}$ | | –24 | |
| I_{OL} | Low-level output current | $V_{CC} = 2.7 \text{ V}$ | | 12 | mA |
| | | $V_{CC} = 3 \text{ V}$ | | 24 | |
| $\Delta t/\Delta V$ | Input transition rise or fall rate | | 0 | 10 | ns/V |
| T_A | Operating free-air temperature | | –40 | 85 | °C |

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} [†] | MIN | TYP [‡] | MAX | UNIT |
|------------------|--|------------------------------|----------------------|------------------|-----|------|
| V _{OH} | I _{OH} = −100 μA | MIN to MAX | V _{CC} −0.2 | | V | |
| | I _{OH} = −12 mA | 2.7 | 2.2 | | | |
| | | 3 | 2.4 | | | |
| | I _{OH} = −24 mA | 3 | 2 | | | |
| V _{OL} | I _{OL} = 100 μA | MIN to MAX | 0.2 | | V | |
| | I _{OL} = 12 mA | 2.7 | 0.4 | | | |
| | I _{OL} = 24 mA | 3 | 0.55 | | | |
| I _I | V _I = 5.5 V or GND | 3.6 | ±5 | | μA | |
| I _{OZ} | V _O = V _{CC} or GND | 3.6 | ±10 | | μA | |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 3.6 | 20 | | μA | |
| ΔI _{CC} | One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND | 3 V to 3.6 V | 500 | | μA | |
| C _i | V _I = V _{CC} or GND | 3.3 | 5.5 | | pF | |
| C _o | V _O = V _{CC} or GND | 3.3 | 5.8 | | pF | |

† For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

‡ All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

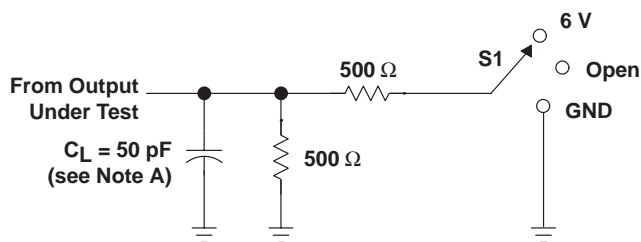
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | $V_{CC} = 2.7 \text{ V}$ | | UNIT |
|-----------|-----------------|-------------|--|-----|--------------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_{pd} | A | Y | 1.5 | 7 | | 8 | ns |
| t_{en} | \overline{OE} | Y | 1.5 | 8 | | 9 | ns |
| t_{dis} | \overline{OE} | Y | 1.5 | 7.5 | | 8.5 | ns |



operating characteristics, $V_{CC} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$

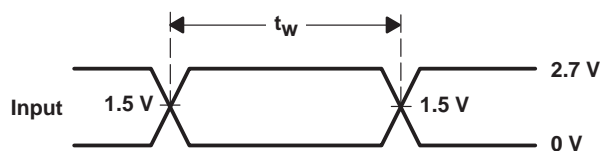
| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|---|--|------|------|
| C_{pd} | Power dissipation capacitance per buffer/driver | $C_L = 50 \text{ pF}$, $f = 10 \text{ MHz}$ | 26.7 | pF |
| | Outputs enabled | | 1.8 | |

PARAMETER MEASUREMENT INFORMATION

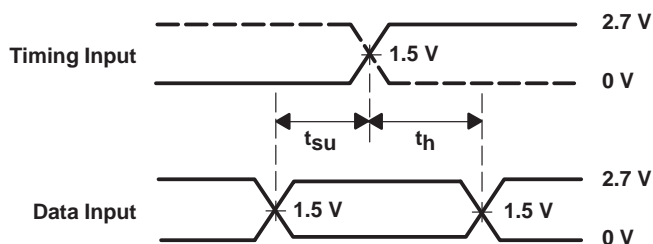


LOAD CIRCUIT FOR OUTPUTS

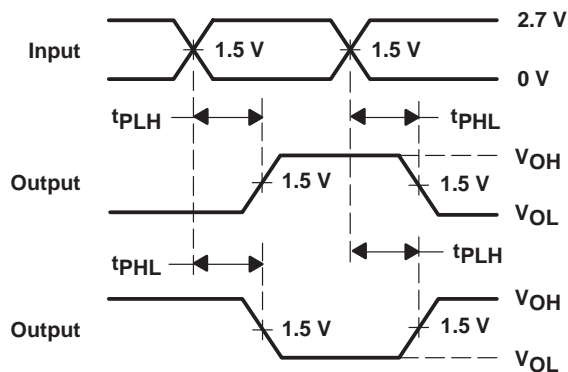
| TEST | S1 |
|-------------------|------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | 6 V |
| t_{PHZ}/t_{PZH} | GND |



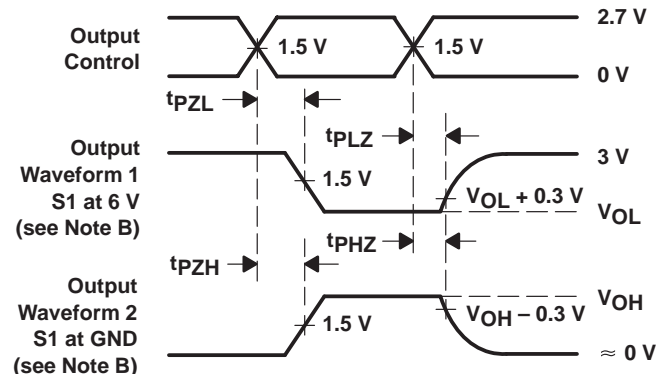
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
F. t_{PZL} and t_{PZH} are the same as t_{en} .
G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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